

**/ Descriptions**

SOT-23          NPN                          Silicon NPN transistor in a SOT-23 Plastic Package.

**/ Features**

Small reverse transfer capacitance, low noise figure.

**/ Applications**

High frequency low noise amplifier.

**/ Equivalent Circuit**



**/ Pinning**



PIN 1   Base          PIN 2   Emitter          PIN 3   Collector

**/ h<sub>FE</sub> Classifications & Marking**

h <sub>FE</sub> Classifications Symbol	R	O	Y
h <sub>FE</sub> Range	40 80	70 140	100 200
Marking	HAQR	HAQO	HAQY

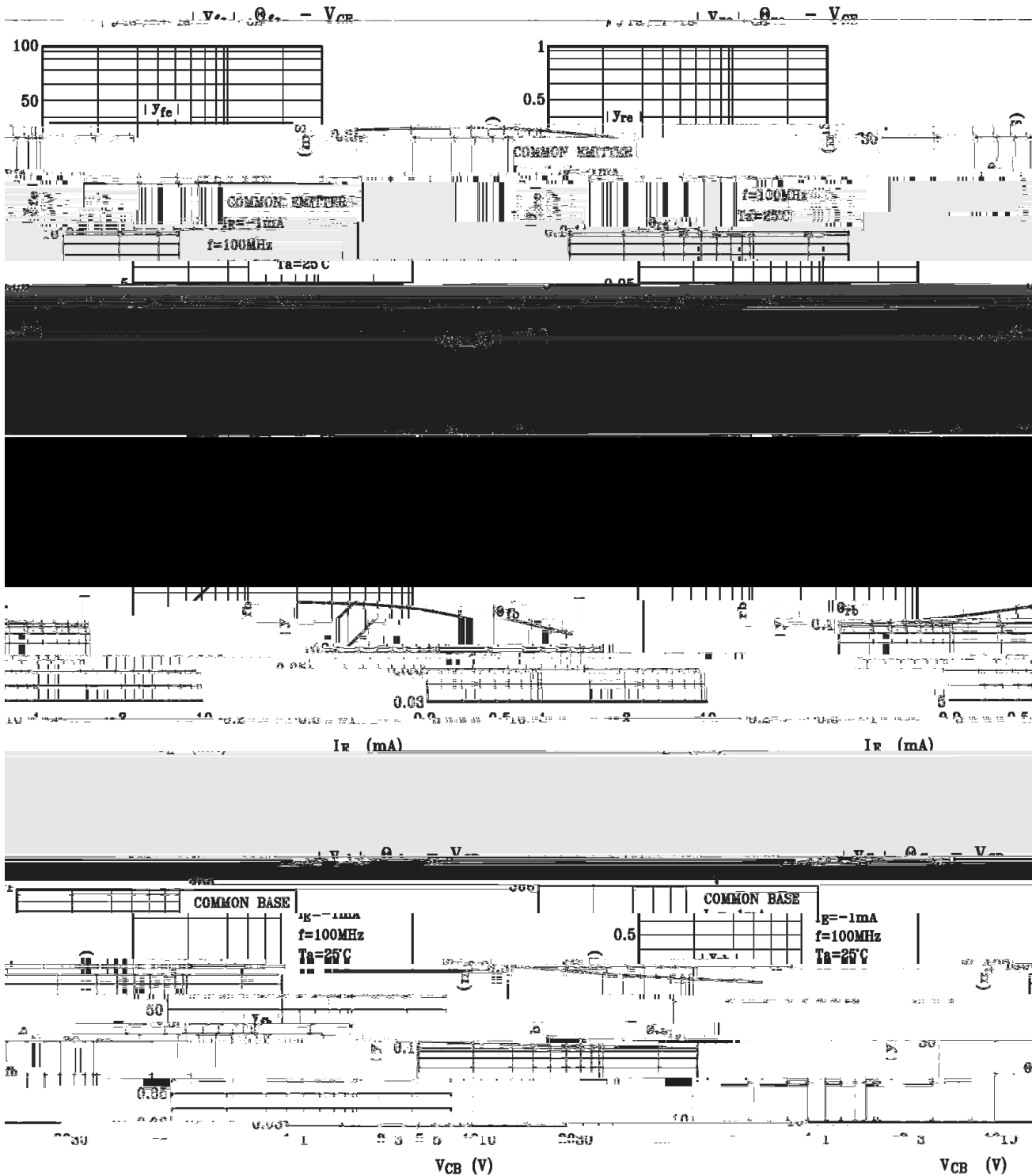
**/ Absolute Maximum Ratings(Ta=25 )**

Parameter	Symbol	Rating	Unit
Collector to Base Voltage	$V_{CBO}$	40	V
Collector to Emitter Voltage	$V_{CEO}$	30	V
Emitter to Base Voltage	$V_{EBO}$	4.0	V
Collector Current	$I_C$	20	mA
Emitter Current	$I_E$	-20	mA
Collector Power Dissipation	$P_C$	150	mW
Junction Temperature	$T_j$	150	
Storage Temperature Range	$T_{stg}$	-55 150	

**/ Electrical Characteristics(Ta=25 )**

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Collector Cut-Off Current	$I_{CBO}$	$V_{CB}=18V$ $I_E=0$			0.5	A
Emitter Cut-Off Current	$I_{EBO}$	$V_{EB}=4.0V$ $I_C=0$			0.5	A
DC Current Gain	$h_{FE}$	$V_{CE}=6.0V$ $I_C=1.0mA$	40		200	
Reverse Transfer Capacitance	$C_{re}$	$V_{CE}=6.0V$ $f=1.0MHz$		0.7		pF
Transition Frequency	$f_T$	$V_{CE}=6.0V$ $I_C=1.0mA$		550		MHz
Collector- Base Time Constant	$C_{c.rbb}$	$V_{CE}=6.0V$ $f=30MHz$ $I_E=1.0mA$			30	pS
Noise Figure	NF	$V_{CE}=6.0V$ $f=100MHz$ $I_C=0.1mA$		2.5	5.0	dB
Power Gain	$G_{pe}$	$V_{CE}=6.0V$ $f=100MHz$ $I_C=0.1mA$	15	18		dB

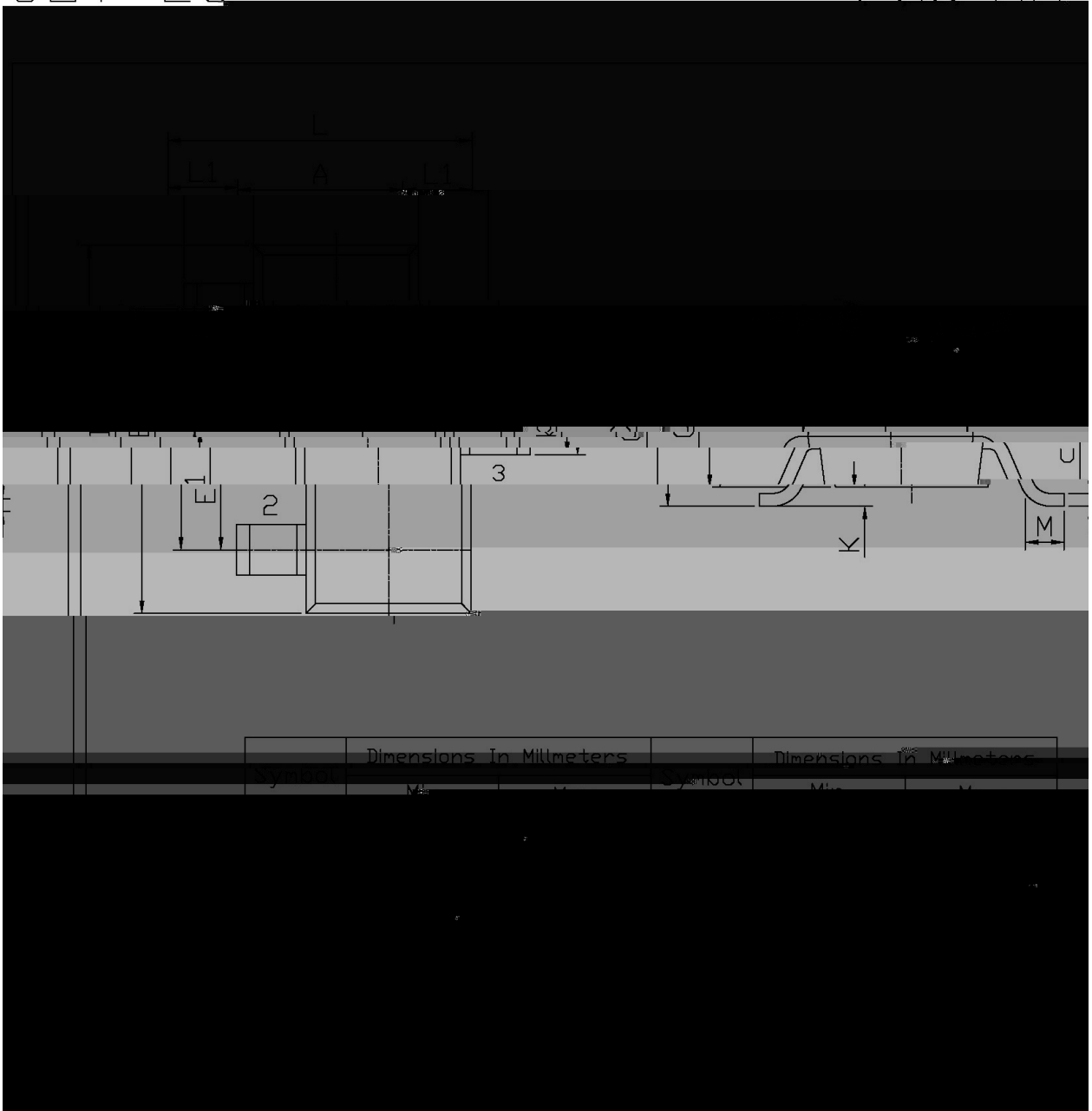
/ Electrical Characteristic Curve



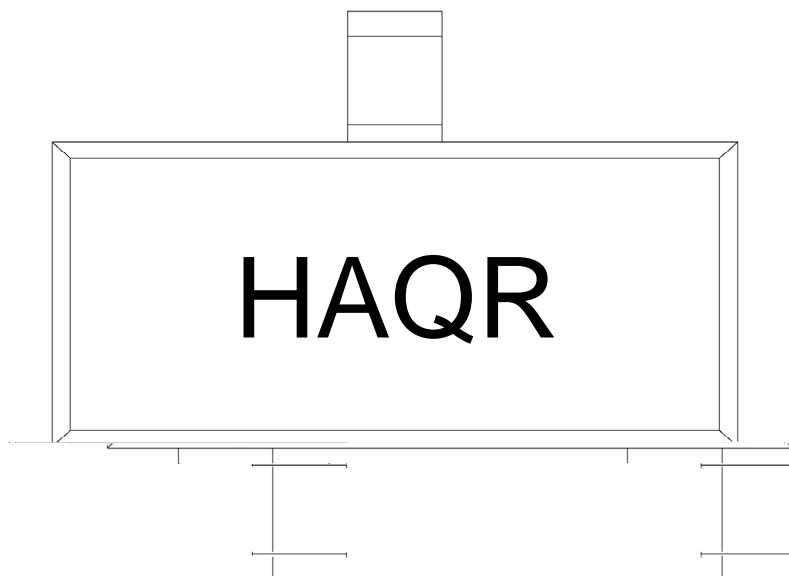
/ Package Dimensions

SOT-23

单位: mm



/ Marking Instructions



H

AQ

R             $h_{FE}$

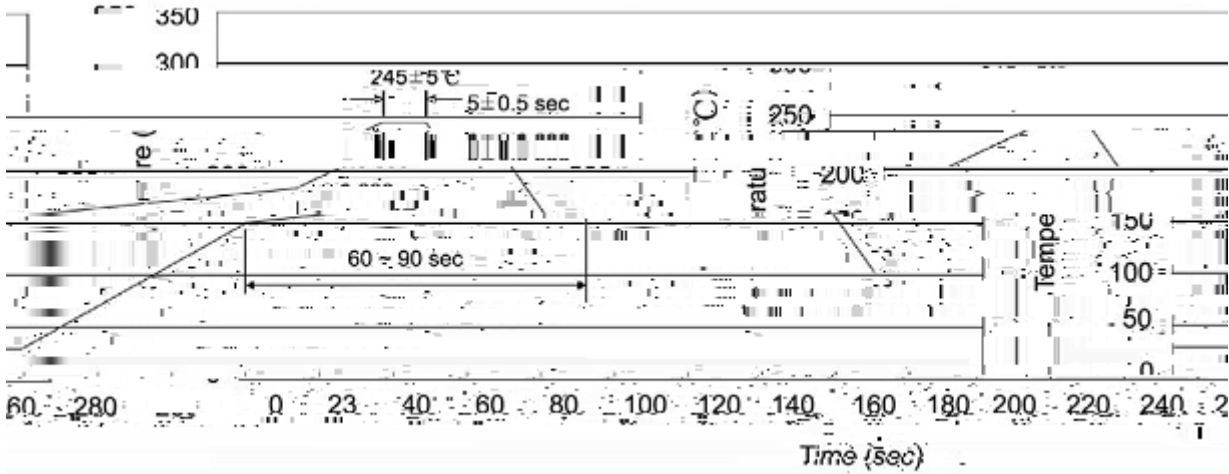
Note:

H            Company Code

AQ          Product Type

R             $h_{FE}$  Classifications Symbol

( ) / Temperature Profile for IR Reflow Soldering(Pb-Free)



Note:

- |   |        |           |   |
|---|--------|-----------|---|
| 1 | 25 150 | 60 90sec; | 1.Preheating:25~150 , Time:60~90sec.    |
| 2 | 245±5  | 5±0.5sec; | 2.Peak Temp.:245±5 , Duration:5±0.5sec. |
| 3 | 2 10   | /sec.     | 3. Cooling Speed: 2~10 /sec.            |

/ Resistance to Soldering Heat Test Conditions

260±5 5 Time:10±1 sec

/ Packaging SPEC.

/ REEL

P a c k a g e T y p e